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# 74HC164; 74HCT164

# 8-bit serial-in, parallel-out shift register Rev. 7 — 13 June 2013

**Product data sheet** 

#### 1. **General description**

The 74HC164; 74HCT164 is an 8-bit serial-in/parallel-out shift register. The device features two serial data inputs (DSA and DSB), eight parallel data outputs (Q0 to Q7). Data is entered serially through DSA or DSB and either input can be used as an active HIGH enable for data entry through the other input. Data is shifted on the LOW-to-HIGH transitions of the clock (CP) input. A LOW on the master reset input (MR) clears the register and forces all outputs LOW, independently of other inputs. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>.

#### Features and benefits 2.

- Input levels:
  - ◆ For 74HC164: CMOS level
  - For 74HCT164: TTL level
- Gated serial data inputs
- Asynchronous master reset
- Complies with JEDEC standard no. 7A
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V.
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

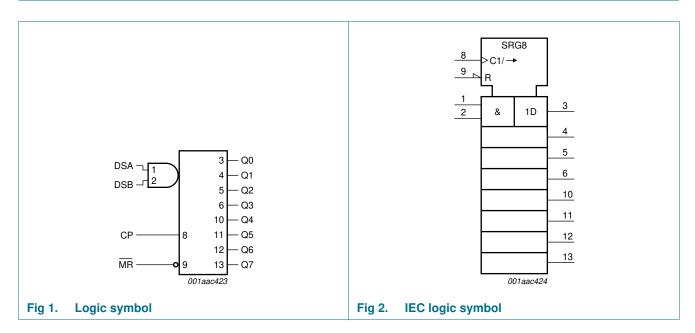


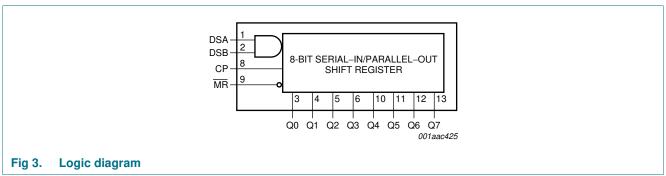
### 3. Ordering information

Table 1. Ordering information

| Type number | Package           |          |  |          |  |  |  |  |  |  |  |  |
|-------------|-------------------|----------|--|----------|--|--|--|--|--|--|--|--|
|             | Temperature range | Name     | Description  | Version  |  |  |  |  |  |  |  |  |
| 74HC164N    | −40 °C to +125 °C | DIP14    | plastic dual in-line package; 14 leads (300 mil)                                   | SOT27-1  |  |  |  |  |  |  |  |  |
| 74HCT164N   |                   |          |  |          |  |  |  |  |  |  |  |  |
| 74HC164D    | −40 °C to +125 °C | SO14     | plastic small outline package; 14 leads; body width                                | SOT108-1 |  |  |  |  |  |  |  |  |
| 74HCT164D   |                   |          | 3.9 mm   |          |  |  |  |  |  |  |  |  |
| 74HC164DB   | −40 °C to +125 °C | SSOP14   | plastic shrink small outline package; 14 leads; body                               | SOT337-1 |  |  |  |  |  |  |  |  |
| 74HCT164DB  |                   |          | width 5.3 mm   |          |  |  |  |  |  |  |  |  |
| 74HC164PW   | –40 °C to +125 °C | TSSOP14  | plastic thin shrink small outline package; 14 leads;                               | SOT402-1 |  |  |  |  |  |  |  |  |
| 74HCT164PW  |                   |          | body width 4.4 mm  |          |  |  |  |  |  |  |  |  |
| 74HC164BQ   | –40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very                              | SOT762-1 |  |  |  |  |  |  |  |  |
| 74HCT164BQ  |                   |          | thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm |          |  |  |  |  |  |  |  |  |

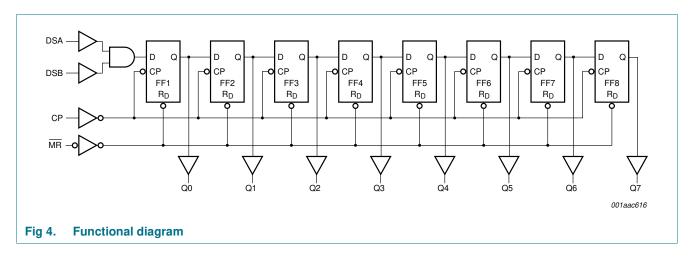
### 4. Functional diagram





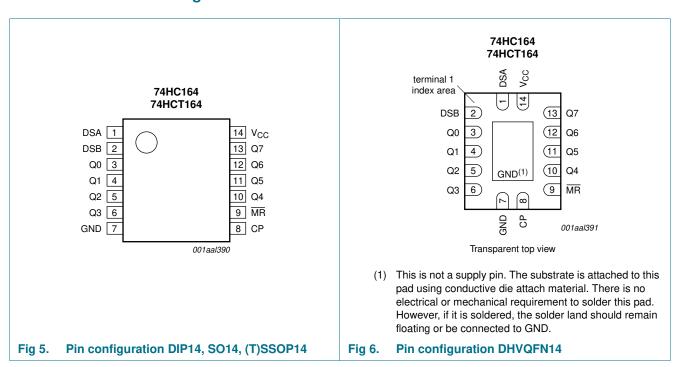
74HC\_HCT164

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### 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2. Pin description

| Symbol          | Pin                        | Description                               |
|-----------------|----------------------------|---|
| DSA             | 1                          | data input                                |
| DSB             | 2                          | data input                                |
| Q0 to Q7        | 3, 4, 5, 6, 10, 11, 12, 13 | output                                    |
| GND             | 7                          | ground (0 V)                              |
| СР              | 8                          | clock input (LOW-to-HIGH, edge-triggered) |
| MR              | 9                          | master reset input (active LOW)           |
| V <sub>CC</sub> | 14                         | positive supply voltage                   |

### 6. Functional description

Table 3. Function table[1]

| Operating     | Input |          | Output | Output |    |          |
|---------------|-------|----------|--------|--------|----|----------|
| modes         | MR    | СР       | DSA    | DSB    | Q0 | Q1 to Q7 |
| Reset (clear) | L     | X        | X      | X      | L  | L to L   |
| Shift         | Н     | <b>↑</b> | I      | I      | L  | q0 to q6 |
|               | Н     | <b>↑</b> | I      | h      | L  | q0 to q6 |
|               | Н     | <b>↑</b> | h      | I      | L  | q0 to q6 |
|               | Н     | <b>↑</b> | h      | h      | Н  | q0 to q6 |

<sup>[1]</sup> H = HIGH voltage level

### 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter               | Conditions  | Min   | Max  | Unit |
|-----------------|-------------------------|---|-------|------|------|
| $V_{CC}$        | supply voltage          |   | -0.5  | +7   | V    |
| I <sub>IK</sub> | input clamping current  | $V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$                       | [1] - | ±20  | mA   |
| I <sub>OK</sub> | output clamping current | $V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$                       | [1] - | ±20  | mA   |
| Io              | output current          | $-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$ | -     | ±25  | mA   |
| I <sub>CC</sub> | supply current          |   | -     | 50   | mA   |
| $I_{GND}$       | ground current          |   | -50   | -    | mA   |
| $T_{stg}$       | storage temperature     |   | -65   | +150 | °C   |

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition

q = lower case letters indicate the state of the referenced input one set-up time prior to the LOW-to-HIGH clock transition

<sup>↑ =</sup> LOW-to-HIGH clock transition

 Table 4.
 Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter                             | Conditions | Min | Max | Unit |
|-----------|---------------------------------------|------------|-----|-----|------|
| $P_{tot}$ | total power dissipation               |            | [2] |     |      |
|           | DIP14 package                         |            | -   | 750 | mW   |
|           | SO14, (T)SSOP14 and DHVQFN14 packages |            | -   | 500 | mW   |

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SO14 package:  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

For (T)SSOP14 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

For DHVQFN14 packages: Ptot derates linearly with 4.5 mW/K above 60 °C.

### 8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol              | Parameter                           | Conditions               | 74HC1 | 64   |          | 74HCT164 |      |          | Unit |
|---------------------|-------------------------------------|--------------------------|-------|------|----------|----------|------|----------|------|
|                     |                                     |                          | Min   | Тур  | Max      | Min      | Тур  | Max      |      |
| $V_{CC}$            | supply voltage                      |                          | 2.0   | 5.0  | 6.0      | 4.5      | 5.0  | 5.5      | ٧    |
| VI                  | input voltage                       |                          | 0     | -    | $V_{CC}$ | 0        | -    | $V_{CC}$ | V    |
| Vo                  | output voltage                      |                          | 0     | -    | $V_{CC}$ | 0        | -    | $V_{CC}$ | ٧    |
| $T_{amb}$           | ambient temperature                 |                          | -40   | +25  | +125     | -40      | +25  | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.0 \text{ V}$ | -     | -    | 625      | -        | -    | -        | ns/V |
|                     |                                     | $V_{CC} = 4.5 \text{ V}$ | -     | 1.67 | 139      | -        | 1.67 | 139      | ns/V |
|                     |                                     | $V_{CC} = 6.0 \text{ V}$ | -     | -    | 83       | -        | -    | -        | ns/V |

#### 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol Parameter |               | Conditions               |      | 25 °C |      | -40 °C to | o +85 °C | -40 °C to +125 °C |      | Unit |
|------------------|---------------|--------------------------|------|-------|------|-----------|----------|-------------------|------|------|
|                  |               |                          | Min  | Тур   | Max  | Min       | Max      | Min               | Max  |      |
| 74HC1            | 64            |                          |      |       |      |           |          |                   |      |      |
| $V_{IH}$         | HIGH-level    | $V_{CC} = 2.0 \text{ V}$ | 1.5  | 1.2   | -    | 1.5       | -        | 1.5               | -    | V    |
|                  | input voltage | V <sub>CC</sub> = 4.5 V  | 3.15 | 2.4   | -    | 3.15      | -        | 3.15              | -    | V    |
|                  |               | $V_{CC} = 6.0 \text{ V}$ | 4.2  | 3.2   | -    | 4.2       | -        | 4.2               | -    | V    |
| $V_{IL}$         | LOW-level     | $V_{CC} = 2.0 \text{ V}$ | -    | 8.0   | 0.5  | -         | 0.5      | -                 | 0.5  | V    |
|                  | input voltage | $V_{CC} = 4.5 \text{ V}$ | -    | 2.1   | 1.35 | -         | 1.35     | -                 | 1.35 | V    |
|                  |               | $V_{CC} = 6.0 \text{ V}$ | -    | 2.8   | 1.8  | -         | 1.8      | -                 | 1.8  | V    |

<sup>[2]</sup> For DIP14 package: Ptot derates linearly with 12 mW/K above 70 °C.

 Table 6.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions   |      | 25 °C |      | –40 °C t | o +85 °C | -40 °C to | o +125 °C | Unit |
|------------------|---------------------------|--|------|-------|------|----------|----------|-----------|-----------|------|
|                  |                           |  | Min  | Тур   | Max  | Min      | Max      | Min       | Max       |      |
| V <sub>OH</sub>  | HIGH-level                | $V_I = V_{IH}$ or $V_{IL}$   |      |       |      |          |          | 1         |           |      |
|                  | output voltage            | $I_O = -20 \mu A$ ; $V_{CC} = 2.0 \text{ V}$   | 1.9  | 2.0   | -    | 1.9      | -        | 1.9       | -         | V    |
|                  |                           | $I_O = -20 \mu A; V_{CC} = 4.5 V$  | 4.4  | 4.5   | -    | 4.4      | -        | 4.4       | -         | V    |
|                  |                           | $I_O = -20 \mu A; V_{CC} = 6.0 V$  | 5.9  | 6.0   | -    | 5.9      | -        | 5.9       | -         | V    |
|                  |                           | $I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$  | 3.98 | 4.32  | -    | 3.84     | -        | 3.7       | -         | V    |
|                  |                           | $I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$  | 5.48 | 5.81  | -    | 5.34     | -        | 5.2       | -         | V    |
| $V_{OL}$         | LOW-level                 | $V_I = V_{IH}$ or $V_{IL}$   |      |       |      |          |          |           |           |      |
|                  | output voltage            | $I_O = 20 \mu A; V_{CC} = 2.0 V$   | -    | 0     | 0.1  | -        | 0.1      | -         | 0.1       | V    |
|                  |                           | $I_O = 20 \mu A; V_{CC} = 4.5 V$   | -    | 0     | 0.1  | -        | 0.1      | -         | 0.1       | V    |
|                  |                           | $I_O = 20 \mu A; V_{CC} = 6.0 V$   | -    | 0     | 0.1  | -        | 0.1      | -         | 0.1       | V    |
|                  |                           | $I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$   | -    | 0.15  | 0.26 | -        | 0.33     | -         | 0.4       | V    |
|                  |                           | $I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$   | -    | 0.16  | 0.26 | -        | 0.33     | -         | 0.4       | V    |
| I <sub>I</sub>   | input leakage<br>current  | $V_I = V_{CC}$ or GND;<br>$V_{CC} = 6.0 \text{ V}$   | -    | -     | ±0.1 | -        | ±1       | -         | ±1        | μΑ   |
| I <sub>CC</sub>  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V   | -    | -     | 8.0  | -        | 80       | -         | 160       | μΑ   |
| Cı               | input<br>capacitance      |  | -    | 3.5   | -    | -        | -        | -         | -         | pF   |
| 74HCT1           | 64                        |  |      |       |      |          |          |           |           |      |
| $V_{IH}$         | HIGH-level input voltage  | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$   | 2.0  | 1.6   | -    | 2.0      | -        | 2.0       | -         | V    |
| $V_{IL}$         | LOW-level input voltage   | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$   | -    | 1.2   | 8.0  | -        | 0.8      | -         | 8.0       | V    |
| $V_{OH}$         | HIGH-level                | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$  |      |       |      |          |          |           |           |      |
|                  | output voltage            | $I_O = -20 \mu A$  | 4.4  | 4.5   | -    | 4.4      | -        | 4.4       | -         | V    |
|                  |                           | $I_{O} = -4.0 \text{ mA}$  | 3.98 | 4.32  | -    | 3.84     | -        | 3.7       | -         | V    |
| $V_{OL}$         | LOW-level                 | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$  |      |       |      |          |          |           |           |      |
|                  | output voltage            | $I_O = 20 \mu A; V_{CC} = 4.5 V$   | -    | 0     | 0.1  | -        | 0.1      | -         | 0.1       | V    |
|                  |                           | $I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$   | -    | 0.15  | 0.26 | -        | 0.33     | -         | 0.4       | V    |
| l <sub>l</sub>   | input leakage<br>current  | $V_I = V_{CC}$ or GND;<br>$V_{CC} = 6.0 \text{ V}$   | -    | -     | ±0.1 | -        | ±1       | -         | ±1        | μА   |
| I <sub>CC</sub>  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$   | -    | -     | 8    | -        | 80       | -         | 160       | μΑ   |
| Δl <sub>CC</sub> | additional supply current | per input pin; $V_I = V_{CC} - 2.1 \text{ V; } I_O = 0 \text{ A;}$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | -    | 100   | 360  | -        | 450      | -         | 490       | μА   |
| Cı               | input<br>capacitance      |  | -    | 3.5   | -    | -        | -        | -         | -         | pF   |

### 10. Dynamic characteristics

Table 7. Dynamic characteristics

 $GND = 0 \ V$ ;  $t_r = t_f = 6 \ ns$ ;  $C_L = 50 \ pF$ ; test circuit see Figure 10; unless otherwise specified

| Symbol           | Parameter       | Conditions                                    |     | 25 °C | :   | -40 °C | to +85 °C | -40 °C t | o +125 °C | Uni |
|------------------|-----------------|---|-----|-------|-----|--------|-----------|----------|-----------|-----|
|                  |                 |   | Mir | Тур   | Max | Min    | Max       | Min      | Max       |     |
| 74HC164          | ı               | '   | '   | '     |     |        | '         |          |           |     |
| t <sub>pd</sub>  | propagation     | CP to Qn; see Figure 7                        | [1] |       |     |        |           |          |           |     |
|                  | delay           | $V_{CC} = 2.0 \text{ V}$                      | -   | 41    | 170 | -      | 215       | -        | 255       | ns  |
|                  |                 | $V_{CC} = 4.5 \text{ V}$                      | -   | 15    | 34  | -      | 43        | -        | 51        | ns  |
|                  |                 | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$ | -   | 12    | -   | -      | -         | -        | -         | ns  |
|                  |                 | $V_{CC} = 6.0 \text{ V}$                      | -   | 12    | 29  | -      | 37        | -        | 43        | ns  |
| t <sub>PHL</sub> | HIGH to LOW     | MR to Qn; see Figure 8                        |     |       |     |        |           |          |           |     |
|                  | propagation     | $V_{CC} = 2.0 \text{ V}$                      | -   | 39    | 140 | -      | 175       | -        | 210       | ns  |
|                  | delay           | $V_{CC} = 4.5 \text{ V}$                      | -   | 14    | 28  | -      | 35        | -        | 42        | ns  |
|                  |                 | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$ | -   | 11    | -   | -      | -         | -        | -         | ns  |
|                  |                 | $V_{CC} = 6.0 \text{ V}$                      | -   | 11    | 24  | -      | 30        | -        | 36        | ns  |
| t <sub>t</sub>   | transition time | see Figure 7                                  | [2] |       |     |        |           |          |           |     |
|                  |                 | $V_{CC} = 2.0 \text{ V}$                      | -   | 19    | 75  | -      | 95        | -        | 110       | ns  |
|                  |                 | V <sub>CC</sub> = 4.5 V                       | -   | 7     | 15  | -      | 19        | -        | 22        | ns  |
|                  |                 | V <sub>CC</sub> = 6.0 V                       | -   | 6     | 13  | -      | 16        | -        | 19        | ns  |
| t <sub>W</sub>   | pulse width     | CP HIGH or LOW;<br>see Figure 7               |     |       |     |        |           |          |           |     |
|                  |                 | V <sub>CC</sub> = 2.0 V                       | 80  | 14    | -   | 100    | -         | 120      | -         | ns  |
|                  |                 | $V_{CC} = 4.5 \text{ V}$                      | 16  | 5     | -   | 20     | -         | 24       | -         | ns  |
|                  |                 | $V_{CC} = 6.0 \text{ V}$                      | 14  | 4     | -   | 17     | -         | 20       | -         | ns  |
|                  |                 | MR LOW; see Figure 8                          |     |       |     |        |           |          |           |     |
|                  |                 | $V_{CC} = 2.0 \text{ V}$                      | 60  | 17    | -   | 75     | -         | 90       | -         | ns  |
|                  |                 | V <sub>CC</sub> = 4.5 V                       | 12  | 6     | -   | 15     | -         | 18       | -         | ns  |
|                  |                 | $V_{CC} = 6.0 \text{ V}$                      | 10  | 5     | -   | 13     | -         | 15       | -         | ns  |
| t <sub>rec</sub> | recovery time   | MR to CP; see Figure 8                        |     |       |     |        |           |          |           |     |
|                  |                 | V <sub>CC</sub> = 2.0 V                       | 60  | 17    | -   | 75     | -         | 90       | -         | ns  |
|                  |                 | V <sub>CC</sub> = 4.5 V                       | 12  | 6     | -   | 15     | -         | 18       | -         | ns  |
|                  |                 | V <sub>CC</sub> = 6.0 V                       | 10  | 5     | -   | 13     | -         | 15       | -         | ns  |
| t <sub>su</sub>  | set-up time     | DSA, and DSB to CP;<br>see Figure 9           |     |       |     |        |           |          |           |     |
|                  |                 | V <sub>CC</sub> = 2.0 V                       | 60  | 8     | -   | 75     | -         | 90       | -         | ns  |
|                  |                 | V <sub>CC</sub> = 4.5 V                       | 12  | 3     | -   | 15     | -         | 18       | -         | ns  |
|                  |                 | V <sub>CC</sub> = 6.0 V                       | 10  | 2     | -   | 13     | -         | 15       | -         | ns  |
| t <sub>h</sub>   | hold time       | DSA, and DSB to CP;<br>see Figure 9           |     |       |     |        |           |          |           |     |
|                  |                 | V <sub>CC</sub> = 2.0 V                       | +4  | -6    | -   | 4      | -         | 4        | -         | ns  |
|                  |                 | V <sub>CC</sub> = 4.5 V                       | +4  | -2    | -   | 4      | -         | 4        | -         | ns  |
|                  |                 | V <sub>CC</sub> = 6.0 V                       | +4  | -2    | -   | 4      | _         | 4        | _         | ns  |

74HC\_HCT164

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 Table 7.
 Dynamic characteristics ...continued

 $GND = 0 \ V; t_r = t_f = 6 \ ns; C_L = 50 \ pF;$  test circuit see Figure 10; unless otherwise specified

| Symbol                    | Parameter                           | Conditions  |     |     | 25 °C |     | –40 °C t | o +85 °C | –40 °C to | +125 °C | Unit |
|---------------------------|-------------------------------------|---|-----|-----|-------|-----|----------|----------|-----------|---------|------|
|                           |                                     |   |     | Min | Тур   | Max | Min      | Max      | Min       | Max     |      |
| f <sub>max</sub>          | maximum                             | for Cp, see Figure 7                                    |     |     |       |     |          |          |           |         |      |
|                           | frequency                           | $V_{CC} = 2.0 \text{ V}$                                |     | 6   | 23    | -   | 5        | -        | 4         | -       | MHz  |
|                           |                                     | $V_{CC} = 4.5 \text{ V}$                                |     | 30  | 71    | -   | 24       | -        | 20        | -       | MHz  |
|                           |                                     | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$           |     | -   | 78    | -   | -        | -        | -         | -       | MHz  |
|                           |                                     | $V_{CC} = 6.0 \text{ V}$                                |     | 35  | 85    | -   | 28       | -        | 24        | -       | MHz  |
| C <sub>PD</sub>           | power<br>dissipation<br>capacitance | per package;<br>V <sub>I</sub> = GND to V <sub>CC</sub> | [3] | -   | 40    | -   | -        | -        | -         | -       | pF   |
| 74HCT16                   | 64                                  |   |     |     |       |     |          |          |           |         |      |
| t <sub>pd</sub>           | propagation                         | CP to Qn; see Figure 7                                  | [1] |     |       |     |          |          |           |         |      |
|                           | delay                               | $V_{CC} = 4.5 \text{ V}$                                |     | -   | 17    | 36  | -        | 45       | -         | 54      | ns   |
|                           |                                     | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$           |     | -   | 14    | -   | -        | -        | -         | -       | ns   |
| t <sub>PHL</sub>          | HIGH to LOW                         | MR to Qn; see Figure 8                                  |     |     |       |     |          |          |           |         |      |
|                           | propagation<br>delay                | $V_{CC} = 4.5 \text{ V}$                                |     | -   | 19    | 38  | -        | 48       | -         | 57      | ns   |
|                           | uelay                               | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$           |     | -   | 16    | -   | -        | -        | -         | -       | ns   |
| t <sub>t</sub> transition | transition time                     | see Figure 7  | [2] |     |       |     |          |          |           |         |      |
|                           |                                     | $V_{CC} = 4.5 \text{ V}$                                |     | -   | 7     | 15  | -        | 19       | -         | 22      | ns   |
| $t_W$                     | pulse width                         | CP HIGH or LOW; see Figure 7                            |     |     |       |     |          |          |           |         |      |
|                           |                                     | $V_{CC} = 4.5 \text{ V}$                                |     | 18  | 7     | -   | 23       | -        | 27        | -       | ns   |
|                           |                                     | MR LOW; see Figure 8                                    |     |     |       |     |          |          |           |         |      |
|                           |                                     | $V_{CC} = 4.5 \text{ V}$                                |     | 18  | 10    | -   | 23       | -        | 27        | -       | ns   |
| t <sub>rec</sub>          | recovery time                       | MR to CP; see Figure 8                                  |     |     |       |     |          |          |           |         |      |
|                           |                                     | $V_{CC} = 4.5 \text{ V}$                                |     | 16  | 7     | -   | 20       | -        | 24        | -       | ns   |
| t <sub>su</sub>           | set-up time                         | DSA, and DSB to CP;<br>see Figure 9                     |     |     |       |     |          |          |           |         |      |
|                           |                                     | $V_{CC} = 4.5 \text{ V}$                                |     | 12  | 6     | -   | 15       | -        | 18        | -       | ns   |
| t <sub>h</sub>            | hold time                           | DSA, and DSB to CP;<br>see Figure 9                     |     |     |       |     |          |          |           |         |      |
|                           |                                     | $V_{CC} = 4.5 \text{ V}$                                |     | +4  | -2    | -   | 4        | -        | 4         | -       | ns   |
| f <sub>max</sub>          | maximum                             | for Cp, see Figure 7                                    |     |     |       |     |          |          |           |         |      |
|                           | frequency                           | $V_{CC} = 4.5 \text{ V}$                                |     | 27  | 55    | -   | 22       | -        | 18        | -       | MHz  |
|                           |                                     | $V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$           |     | -   | 61    | -   | -        | -        | -         | -       | MHz  |

 Table 7.
 Dynamic characteristics ...continued

 $GND = 0 \ V$ ;  $t_r = t_f = 6 \ ns$ ;  $C_L = 50 \ pF$ ; test circuit see Figure 10; unless otherwise specified

| Symbol   | Parameter                           | Conditions  | 25 °C |     | -40 °C to +85 °C |     | -40 °C to +125 °C |     | Unit |    |
|----------|-------------------------------------|---|-------|-----|------------------|-----|-------------------|-----|------|----|
|          |                                     |   | Min   | Тур | Max              | Min | Max               | Min | Max  |    |
| $C_{PD}$ | power<br>dissipation<br>capacitance | per package; $V_I = GND \text{ to } V_{CC} - 1.5 \text{ V}$ | -     | 40  | -                | -   | -                 | -   | -    | pF |

- [1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .
- [2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$$
 where:

f<sub>i</sub> = input frequency in MHz;

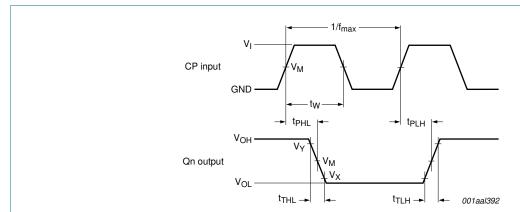
f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 



(1) Measurement points are given in Table 8.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

Fig 7. Waveforms showing the clock (CP) to output (Qn) propagation delays, the clock pulse width, the output transition times and the maximum clock frequency

Table 8. Measurement points

| Туре     | Input              | Output             |                    |                    |  |  |  |  |
|----------|--------------------|--------------------|--------------------|--------------------|--|--|--|--|
|          | $V_{M}$            | V <sub>M</sub>     | $V_X$              | V <sub>Y</sub>     |  |  |  |  |
| 74HC164  | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> | 0.1V <sub>CC</sub> | 0.9V <sub>CC</sub> |  |  |  |  |
| 74HCT164 | 1.3 V              | 1.3 V              | 0.1V <sub>CC</sub> | 0.9V <sub>CC</sub> |  |  |  |  |

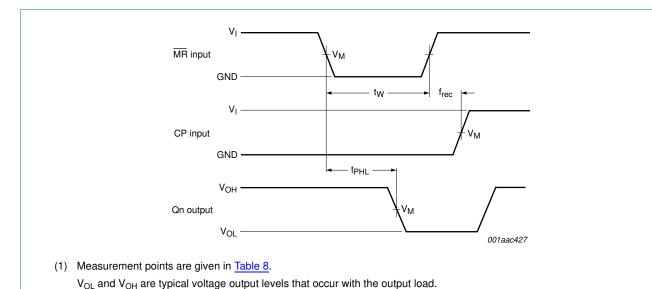
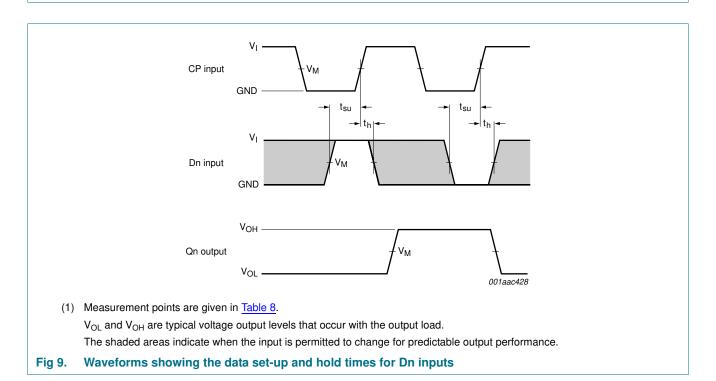
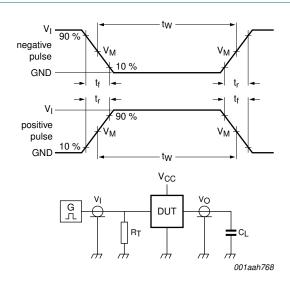


Fig 8. Waveforms showing the master reset (MR) pulse width, the master reset to output (Qn) propagation delays and the master reset to clock (CP) removal time



10 of 20



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

 $C_L$  = load capacitance including jig and probe capacitance.

Fig 10. Test circuit for measuring switching times

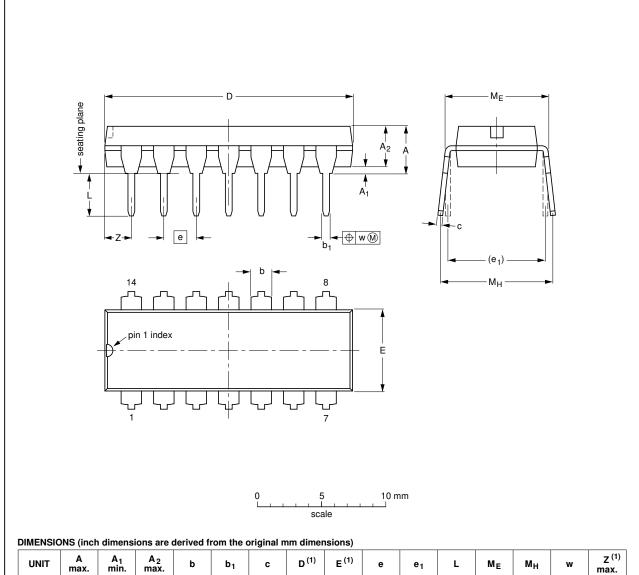
Table 9. Test data

| Туре     | Input           |                                 | Load         | Test                                |
|----------|-----------------|---------------------------------|--------------|-------------------------------------|
|          | VI              | t <sub>r</sub> , t <sub>f</sub> | CL           |                                     |
| 74HC164  | V <sub>CC</sub> | 6.0 ns                          | 15 pF, 50 pF | t <sub>PLH</sub> , t <sub>PHL</sub> |
| 74HCT164 | 3.0 V           | 6.0 ns                          | 15 pF, 50 pF | t <sub>PLH</sub> , t <sub>PHL</sub> |

### 11. Package outline

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



| UNIT   | A<br>max. | A <sub>1</sub><br>min. | A <sub>2</sub><br>max. | b              | b <sub>1</sub> | С              | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | e <sub>1</sub> | L            | ME           | Мн           | w     | Z <sup>(1)</sup><br>max. |
|--------|-----------|------------------------|------------------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|--------------|--------------|-------|--------------------------|
| mm     | 4.2       | 0.51                   | 3.2                    | 1.73<br>1.13   | 0.53<br>0.38   | 0.36<br>0.23   | 19.50<br>18.55   | 6.48<br>6.20     | 2.54 | 7.62           | 3.60<br>3.05 | 8.25<br>7.80 | 10.0<br>8.3  | 0.254 | 2.2                      |
| inches | 0.17      | 0.02                   | 0.13                   | 0.068<br>0.044 | 0.021<br>0.015 | 0.014<br>0.009 | 0.77<br>0.73     | 0.26<br>0.24     | 0.1  | 0.3            | 0.14<br>0.12 | 0.32<br>0.31 | 0.39<br>0.33 | 0.01  | 0.087                    |

#### Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

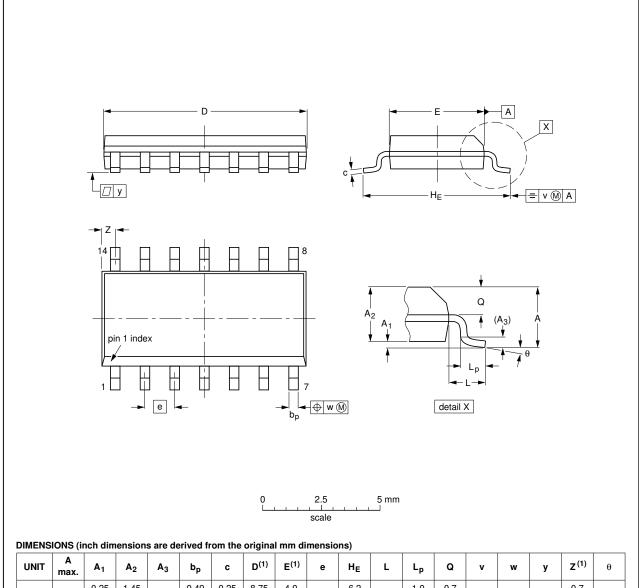
| OUTLINE |        | REFER  | ENCES     | EUROPEAN   | ISSUE DATE                      |
|---------|--------|--------|-----------|------------|---------------------------------|
| VERSION | IEC    | JEDEC  | JEITA     | PROJECTION | ISSUE DATE                      |
| SOT27-1 | 050G04 | MO-001 | SC-501-14 |            | <del>99-12-27</del><br>03-02-13 |

Fig 11. Package outline SOT27-1 (DIP14)

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



| UNIT   | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С                | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE             | L     | Lp             | Q              | v    | w    | у     | Z <sup>(1)</sup> | θ  |
|--------|-----------|----------------|----------------|----------------|--------------|------------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----|
| mm     | 1.75      | 0.25<br>0.10   | 1.45<br>1.25   | 0.25           | 0.49<br>0.36 | 0.25<br>0.19     | 8.75<br>8.55     | 4.0<br>3.8       | 1.27 | 6.2<br>5.8     | 1.05  | 1.0<br>0.4     | 0.7<br>0.6     | 0.25 | 0.25 | 0.1   | 0.7<br>0.3       | 8° |
| inches | 0.069     | 0.010<br>0.004 | 0.057<br>0.049 | 0.01           | 1            | 0.0100<br>0.0075 | 0.35<br>0.34     | 0.16<br>0.15     | 0.05 | 0.244<br>0.228 | 0.041 | 0.039<br>0.016 | 0.028<br>0.024 | 0.01 | 0.01 | 0.004 | 0.028<br>0.012   | 0° |

#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

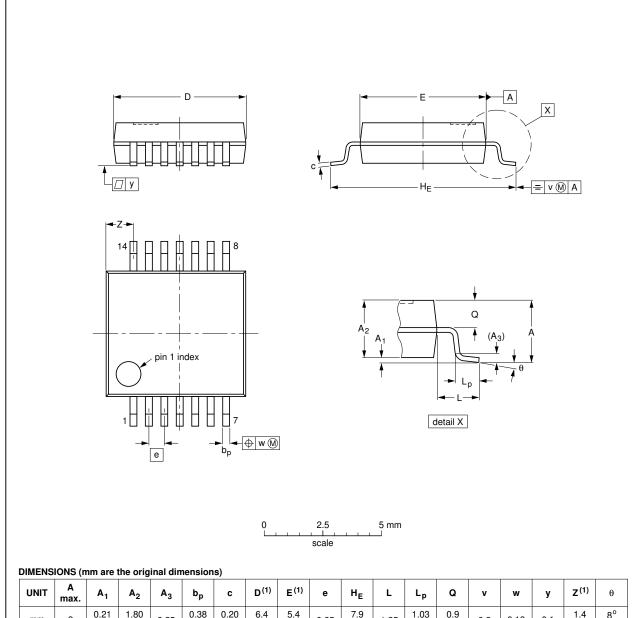
| OUTLINE  |        | REFER  | ENCES | EUROPEAN | ISSUE DATE |                                 |
|----------|--------|--------|-------|----------|------------|---------------------------------|
| VERSION  | IEC    | JEDEC  | JEITA |          | PROJECTION | ISSUE DATE                      |
| SOT108-1 | 076E06 | MS-012 |       |          |            | <del>99-12-27</del><br>03-02-19 |

Fig 12. Package outline SOT108-1 (SO14)

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



|      |           |                |                |                |              | -,           |                  |                  |      |            |      |              |            |     |      |     |                  |          |
|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE         | L    | Lp           | Q          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
| mm   | 2         | 0.21<br>0.05   | 1.80<br>1.65   | 0.25           | 0.38<br>0.25 | 0.20<br>0.09 | 6.4<br>6.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6 | 1.25 | 1.03<br>0.63 | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 1.4<br>0.9       | 8°<br>0° |

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

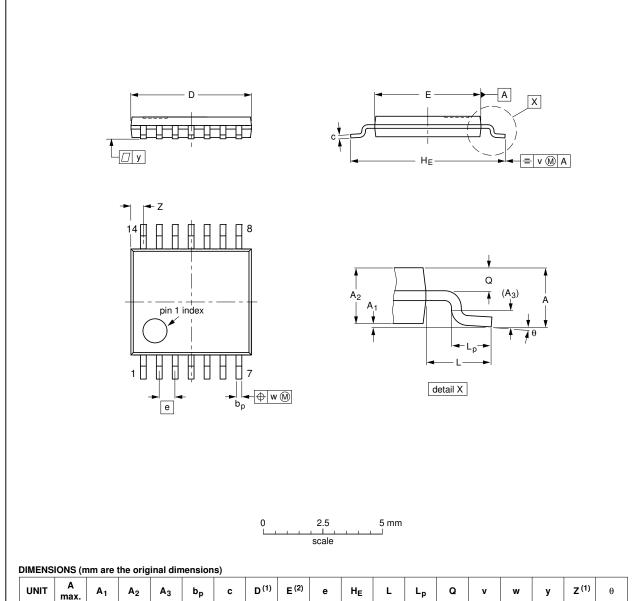
| OUTLINE  |     | REFER  | EUROPEAN | ISSUE DATE |                                  |
|----------|-----|--------|----------|------------|----------------------------------|
| VERSION  | IEC | JEDEC  | JEITA    | PROJECTION | ISSUE DATE                       |
| SOT337-1 |     | MO-150 |          |            | <del>-99-12-27</del><br>03-02-19 |

Fig 13. Package outline SOT337-1 (SSOP14)

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



| - |      |           |                |                |                |              | σ,         |                  |            |      |            |   |              |            |     |      |     |                  |          |
|---|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
|   | UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С          | D <sup>(1)</sup> | E (2)      | е    | HE         | L | Lp           | Q          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
|   | mm   | 1.1       | 0.15<br>0.05   | 0.95<br>0.80   | 0.25           | 0.30<br>0.19 | 0.2<br>0.1 | 5.1<br>4.9       | 4.5<br>4.3 | 0.65 | 6.6<br>6.2 | 1 | 0.75<br>0.50 | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.72<br>0.38     | 8°<br>0° |

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE  |     | REFER  | ENCES | EUROPEAN | ISSUE DATE |                                  |
|----------|-----|--------|-------|----------|------------|----------------------------------|
| VERSION  | IEC | JEDEC  | JEITA |          | PROJECTION | ISSUE DATE                       |
| SOT402-1 |     | MO-153 |       |          |            | <del>-99-12-27</del><br>03-02-18 |
|          |     |        |       |          |            |                                  |

Fig 14. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

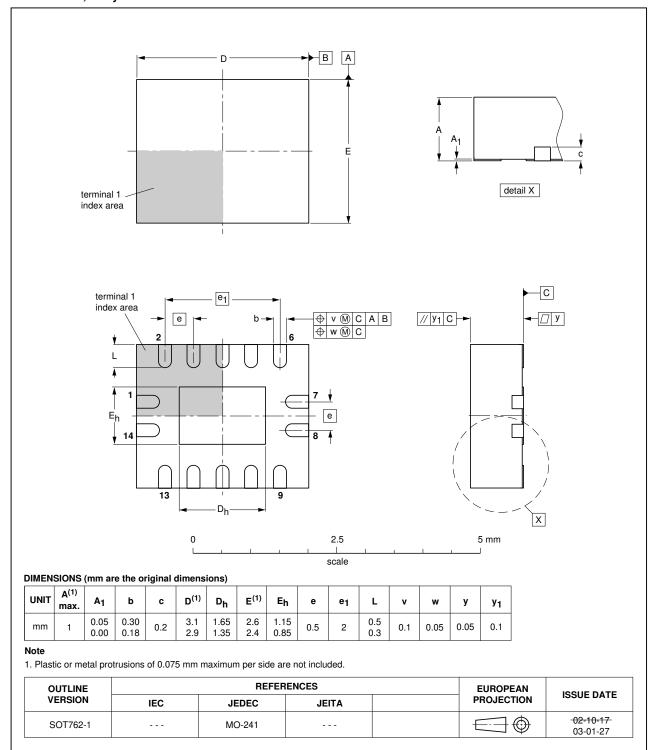


Fig 15. Package outline SOT762-1 (DHVQFN14)

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### 12. Abbreviations

#### Table 10. Abbreviations

| Acronym | Description                                    |
|---------|--|
| CMOS    | Complementary Metal-Oxide Semiconductor        |
| DUT     | Device Under Test                              |
| ESD     | ElectroStatic Discharge                        |
| HBM     | Human Body Model                               |
| LSTTL   | Low-power Schottky Transistor-Transistor Logic |
| MM      | Machine Model                                  |
| TTL     | Transistor-Transistor Logic                    |

### 13. Revision history

#### Table 11. Revision history

| Document ID         | Release date                    | Data sheet status     | Change notice | Supersedes           |
|---------------------|---------------------------------|-----------------------|---------------|----------------------|
| 74HC_HCT164 v.7     | 20130613                        | Product data sheet    | -             | 74HC_HCT164 v.6      |
| Modifications:      | <ul> <li>General des</li> </ul> | cription updated.     |               |                      |
| 74HC_HCT164 v.6     | 20111212                        | Product data sheet    | -             | 74HC_HCT164 v.5      |
| Modifications:      | <ul> <li>Legal pages</li> </ul> | updated.              |               |                      |
| 74HC_HCT164 v.5     | 20101125                        | Product data sheet    | -             | 74HC_HCT164 v.4      |
| 74HC_HCT164 v.4     | 20100202                        | Product data sheet    | -             | 74HC_HCT164 v.3      |
| 74HC_HCT164 v.3     | 20050404                        | Product data sheet    | -             | 74HC_HCT164_ CNV v.2 |
| 74HC_HCT164_CNV v.2 | 19901201                        | Product specification | -             | -                    |

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#### 8-bit serial-in, parallel-out shift register

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Product data sheet

19 of 20

#### **NXP Semiconductors**

8-bit serial-in, parallel-out shift register

### 16. Contents

| 1    | General description                |
|------|------------------------------------|
| 2    | Features and benefits              |
| 3    | Ordering information               |
| 4    | Functional diagram                 |
| 5    | Pinning information                |
| 5.1  | Pinning                            |
| 5.2  | Pin description                    |
| 6    | Functional description             |
| 7    | Limiting values                    |
| 8    | Recommended operating conditions 5 |
| 9    | Static characteristics             |
| 10   | Dynamic characteristics            |
| 11   | Package outline                    |
| 12   | Abbreviations                      |
| 13   | Revision history                   |
| 14   | Legal information                  |
| 14.1 | Data sheet status                  |
| 14.2 | Definitions                        |
| 14.3 | Disclaimers                        |
| 14.4 | Trademarks19                       |
| 15   | Contact information 19             |
| 16   | Contents                           |

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